

Diode

Fast Switching Emitter Controlled Diode

IDV30E60C

FullPAK with Emitter Controlled Diode

Datasheet

Industrial & Multimarket



Features:

- · Electrically isolated FullPAK for easy assembly
- 600 V Emitter Controlled technology
- Fast recovery
- Soft switching
- · Low reverse recovery charge
- Low forward voltage
- · Easy paralleling
- Qualified according to JESD-022 for target applications

Fast Switching Emitter Controlled Diode

- Pb-free lead plating; RoHS compliant
- Halogen free (according to IEC 61249-2-21)
- Complete product spectrum and PSpice Models: http://www.infineon.com/diode/

Applications:

 \bullet Switching diode for PFC applications with operating range up to 30kHz





Key Performance and Package Parameters

| Туре | <i>V</i> rrm | /f | <i>V</i> _f , <i>T</i> _{vj} =25°C | T vjmax | Marking | Package |
|-----------|--------------|-----|--|----------------|---------|------------------|
| IDV30E60C | 600V | 30A | 1.65V | 175°C | D30E60C | PG-TO220-2-22 FP |



Table of Contents

| Description | 2 |
|-------------------------------------|-----|
| Table of Contents | 3 |
| Maximum ratings | . 4 |
| Thermal Resistance | . 4 |
| Electrical Characteristics | 4 |
| Electrical Characteristics diagrams | . 6 |
| Package Drawing | . 9 |
| Testing Conditions | 10 |
| Revision History | 11 |
| Disclaimer | 11 |
| | |



Maximum ratings

| Parameter | Symbol | Value | Unit | |
|--|------------------|--------------|------|--|
| Repetitive peak reverse voltage | VRRM | 600 | V | |
| Diode forward current, limited by T_{vjmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$ | <i>I</i> = | 21.0 12.0 | A | |
| Diode pulsed current, t_{p} limited by T_{vjmax} | Fpuls | 90.0 | A | |
| Power dissipation $T_{\rm C}$ = 25°C | Ptot | 37.0 | W | |
| Operating junction temperature | T _{vj} | -40+175 | °C | |
| Storage temperature | 7 _{stg} | -55+150 | °C | |
| Soldering temperature, wave soldering 1.6 mm (0.063 in.) from case for 10s | | 260 | °C | |
| Mounting torque, M3 screw Maximum of mounting processes: 3 | М | 0.6 | Nm | |

Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
|---|----------------------|------------|------------|------|
| Characteristic | | | | l |
| Diode thermal resistance, ¹⁾ junction - case | R _{th(j-c)} | | 4.00 | K/W |
| Thermal resistance junction - ambient | <i>R</i> th(j⁻a) | | 65 | K/W |

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

| Deverates | 0h.al | | Value | | | 11 14 |
|-------------------------|------------|---|-------|--------------|----------------|-------|
| Parameter | Symbol | Conditions | min. | typ. | max. | Unit |
| Static Characteristic | i | | | | | |
| Diode forward voltage | Vŧ | /≠ = 30.0A <i>T</i> _{vj} = 25°C <i>T</i> _{vj} = 175°C | - | 1.65 1.65 | 2.05 | V |
| Reverse leakage current | <i>I</i> R | $V_{R} = 600V$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 175^{\circ}C$ | | | 40.0 1000.0 | μA |

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

| Parameter | Symbol | Symbol Conditions | | Value | | |
|---|-------------------|-------------------|------|-------|------|------|
| Farameter | Symbol Conditions | | min. | typ. | max. | Unit |
| Dynamic Characteristic | | | | | | |
| Internal emitter inductance measured 5mm (0.197 in.) from case | LE | | - | 7.0 | - | nH |

Switching Characteristic, Inductive Load, at T_{vj} = 25°C

| Parameter | Symbol Conditions | Conditions | Value | | | 11 |
|-----------|-------------------|------------|-------|------|------|------|
| | | Conditions | min. | typ. | max. | Unit |

¹⁾ Please be aware that in non standard load conditions, due to high Rth(j-c), Tvj close to Tvjmax can be reached.



Diode Characteristic, at $T_{vj} = 25^{\circ}C$

| · · · · · · | - 1 | | | | | |
|--|----------------------|------------------------------------|---|------|---|------|
| Diode reverse recovery time | <i>t</i> rr | $T_{\rm vj} = 25^{\circ} {\rm C},$ | - | 130 | - | ns |
| Diode reverse recovery charge | Qrr | l∕R = 400V, /⊧ = 30.0A, | - | 0.88 | - | μC |
| Diode peak reverse recovery current /rrm | | <i>di</i> ⊧ <i>/dt</i> = 1000A/µs | - | 16.9 | - | Α |
| Diode peak rate of fall of reverse recovery current during $t_{\rm b}$ | di _{rr} /dt | | - | -598 | - | A/µs |

Switching Characteristic, Inductive Load, at T_{vj} = 175°C

| Parameter | Symbol | Conditions | | | 11 |
|-----------|--------|------------|------|------|------|
| Parameter | | | min. | typ. | max. |

Diode Characteristic, at $T_{vj} = 175^{\circ}C$

| Diode reverse recovery time | <i>t</i> rr | $T_{\rm vj} = 175^{\circ}{\rm C},$ | - | 217 | - | ns |
|--|-------------|------------------------------------|---|------|---|------|
| Diode reverse recovery charge | Qrr | l∕R = 400V, l≠ = 30.0A, | - | 2.40 | - | μC |
| Diode peak reverse recovery current hrm | | | - | 22.9 | - | Α |
| Diode peak rate of fall of reverse recovery current during t_b d_{rr}/dt | | | - | -307 | - | A/µs |



IDV30E60C

Emitter Controlled Diode







Rev. 2.1 2010-07-26





Figure 9. Typical diode forward voltage as a function of junction temperature



IDV30E60C

Emitter Controlled Diode

PG-TO220-2-22





IDV30E60C

Emitter Controlled Diode



Figure B. Definition of switching losses



Revision History

IDV30E60C

Revision: 2010-07-26, Rev. 2.1

| Previous Revision | | | | | |
|-------------------|------|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | |
| 2.1 | - | Release of final datasheet | | | |

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all ? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 Munich, Germany 81726 München, Germany © 2010 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office. Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.